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(12) **United States Design Patent**
Ahn et al.

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(54) **STAMP**
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(73) Assignee: **SAMSUNG ELECTRONICS CO., LTD.** (KR)

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(**) Term: **14 Years**
(21) Appl. No.: **29/482,214**
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(30) **Foreign Application Priority Data**
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(51) **LOC (10) Cl.** **19-02**
(52) **U.S. Cl.**
USPC **D18/15**
(58) **Field of Classification Search**
USPC D18/15, 16, 17, 18, 50; D19/65-68, 70,
D19/71; 101/104, 333, 334, 327, 328, 405,
101/406; 118/264, 268; D9/521, 544, 545
CPC B41K 1/00; B41K 1/006; B41K 1/02;
B41K 1/08; B41K 1/40; B41K 1/42; B41K
1/52; B41K 1/54; B41K 1/56
See application file for complete search history.

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(57) **CLAIM**
We claim, the ornamental design for a stamp, as shown and described.

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DESCRIPTION

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FIG. 1 is a perspective view of a stamp, showing our new design;
FIG. 2 is a front elevation view thereof;
FIG. 3 is a rear elevation view thereof;
FIG. 4 is a side elevation view thereof;
FIG. 5 is a another side elevation view thereof;
FIG. 6 is a top plan view thereof; and,
FIG. 7 is a bottom plan view thereof.
The broken lines illustrating portions of the stamp are for environmental purposes only and form no part of the claimed design.

1 Claim, 4 Drawing Sheets

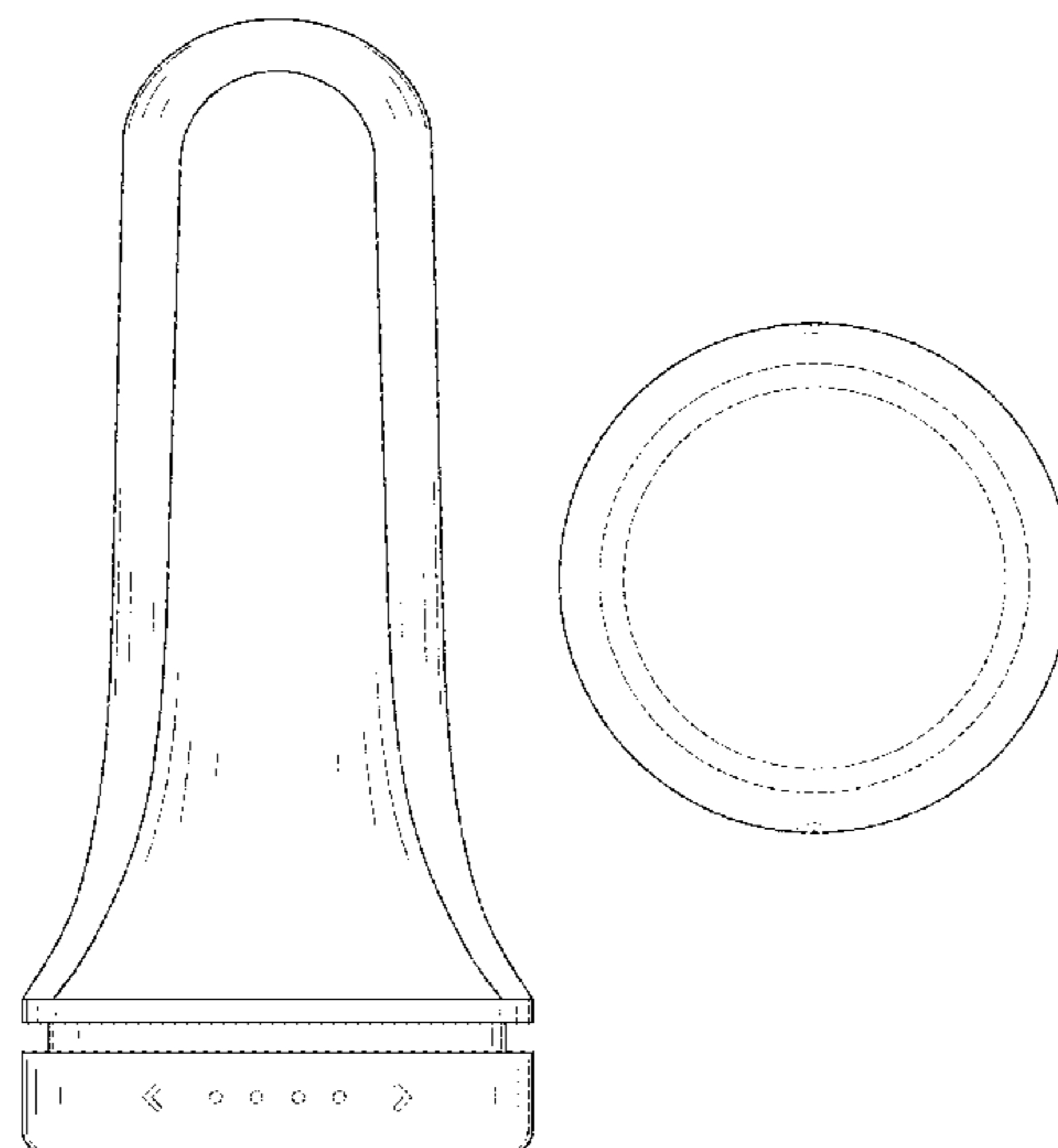


FIG. 1

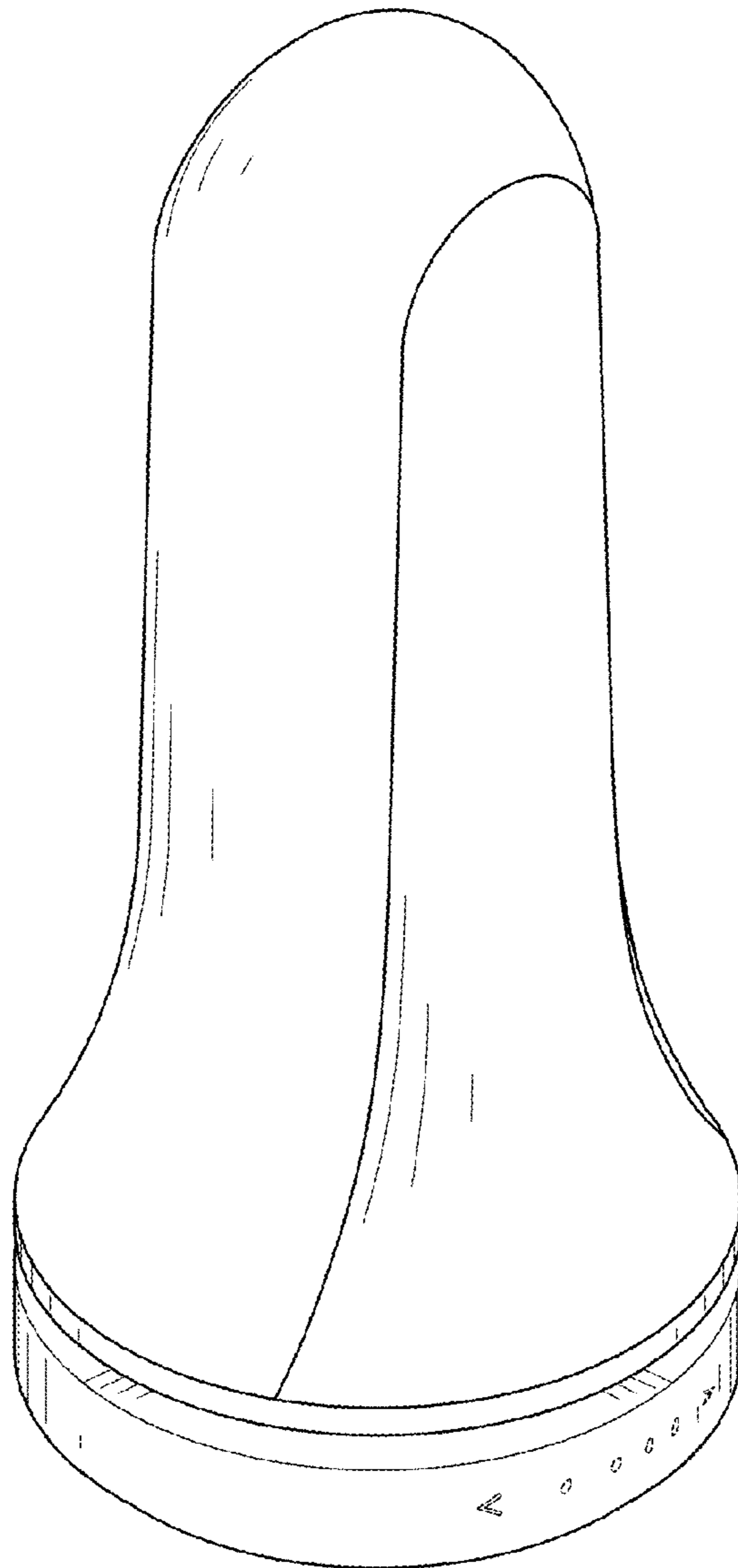


FIG.2

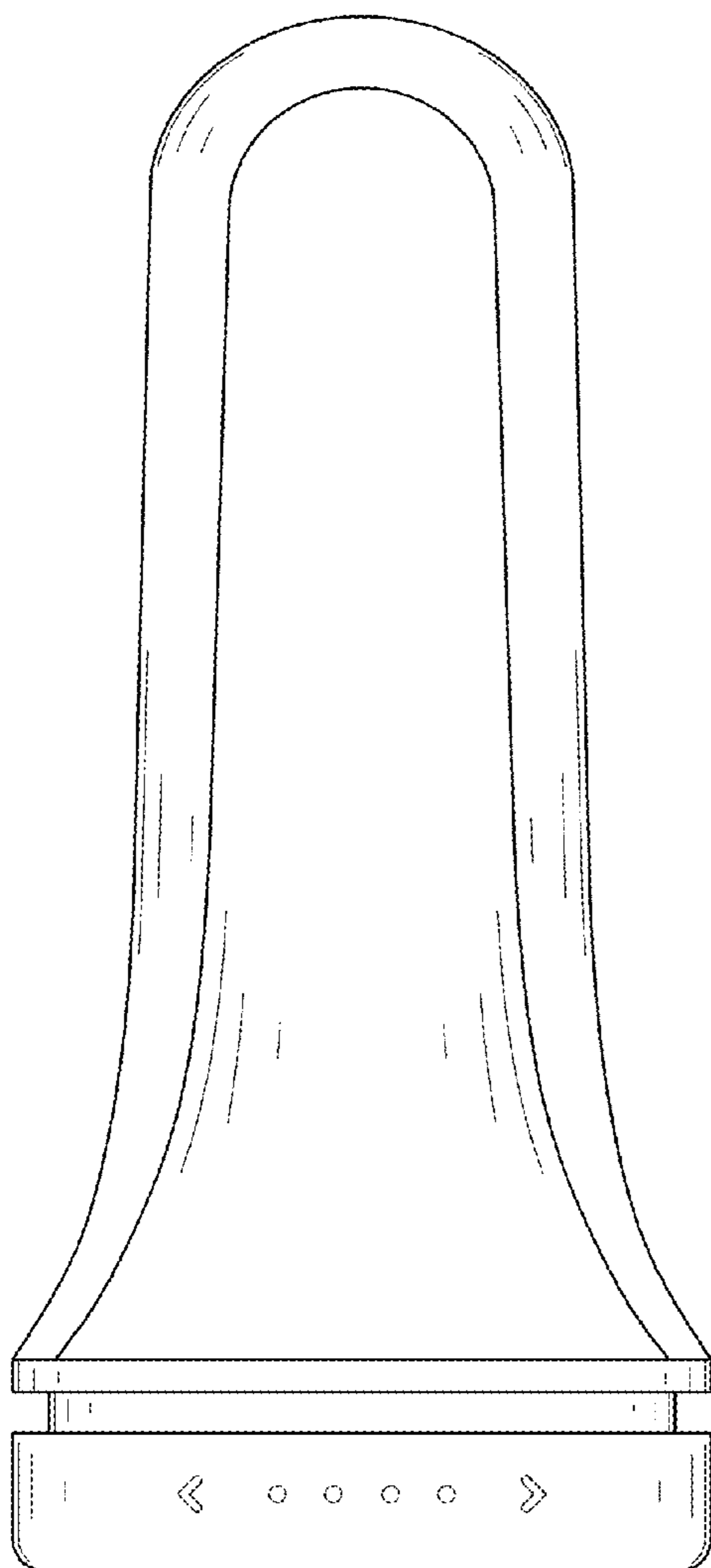


FIG.3

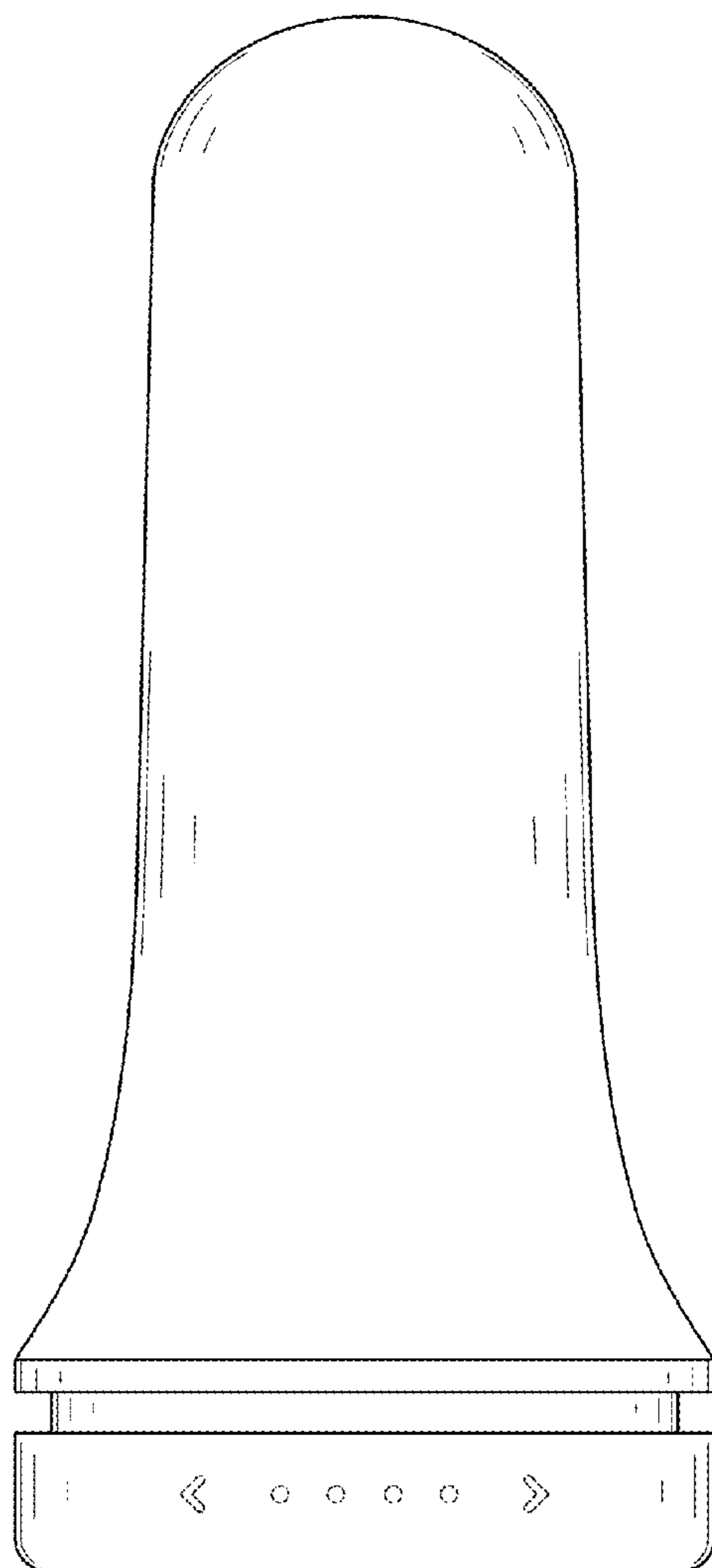


FIG.4

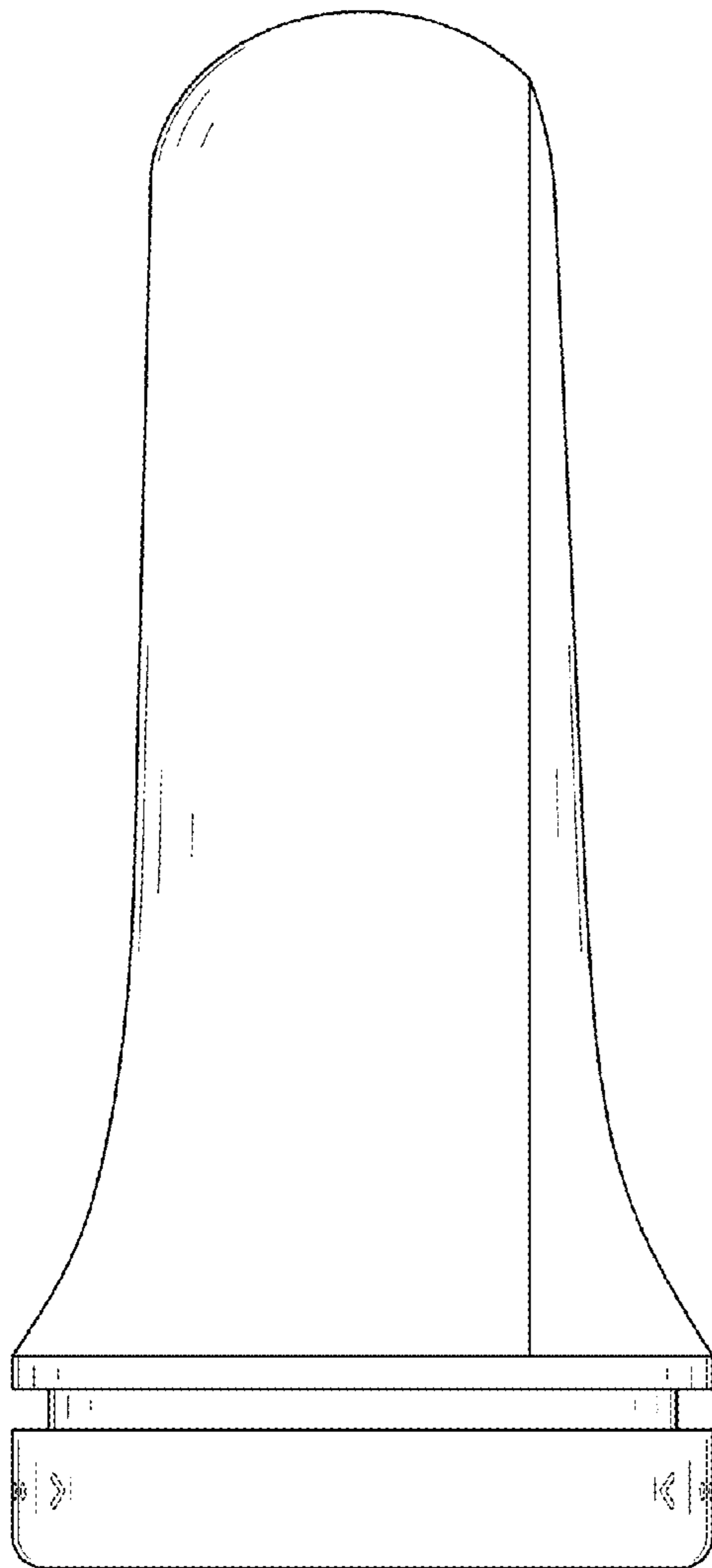


FIG.5

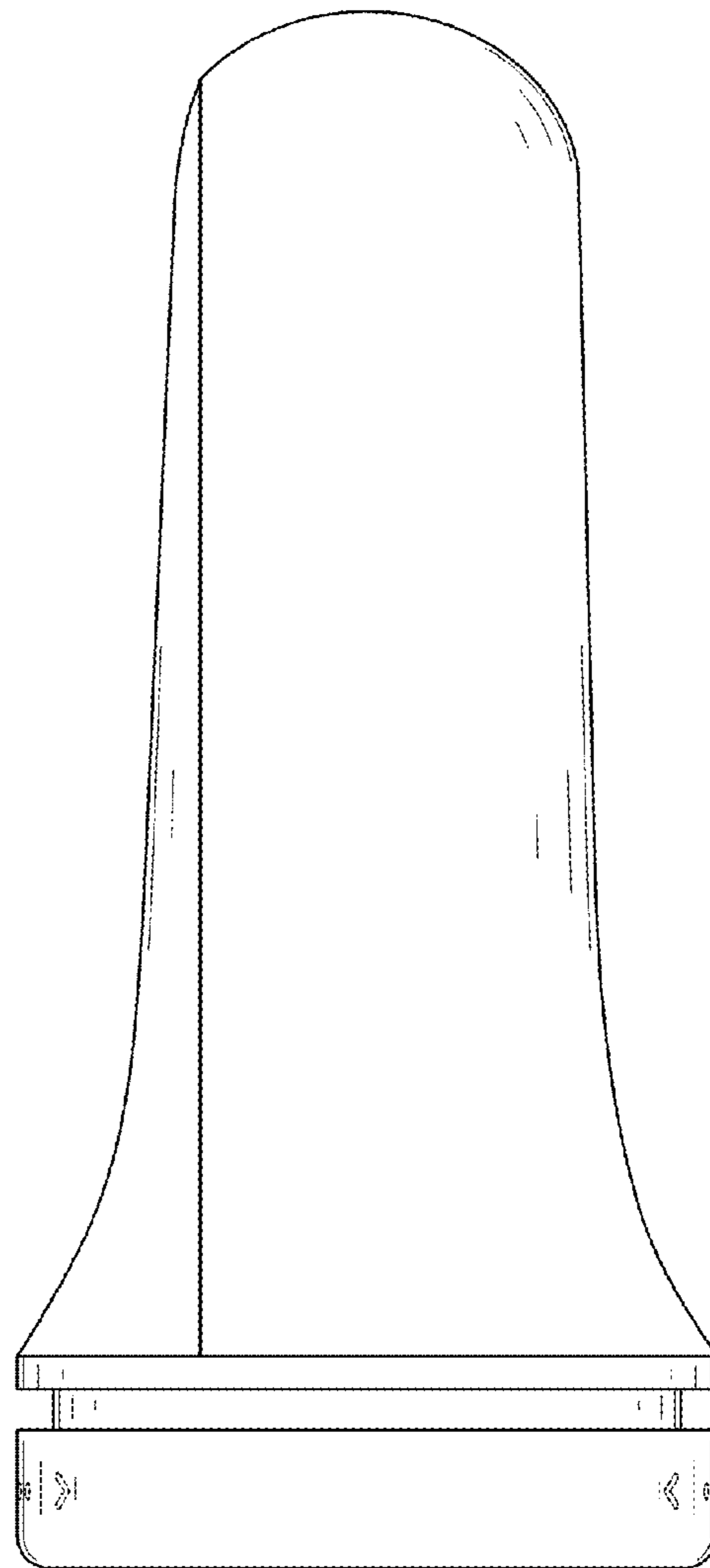


FIG. 6

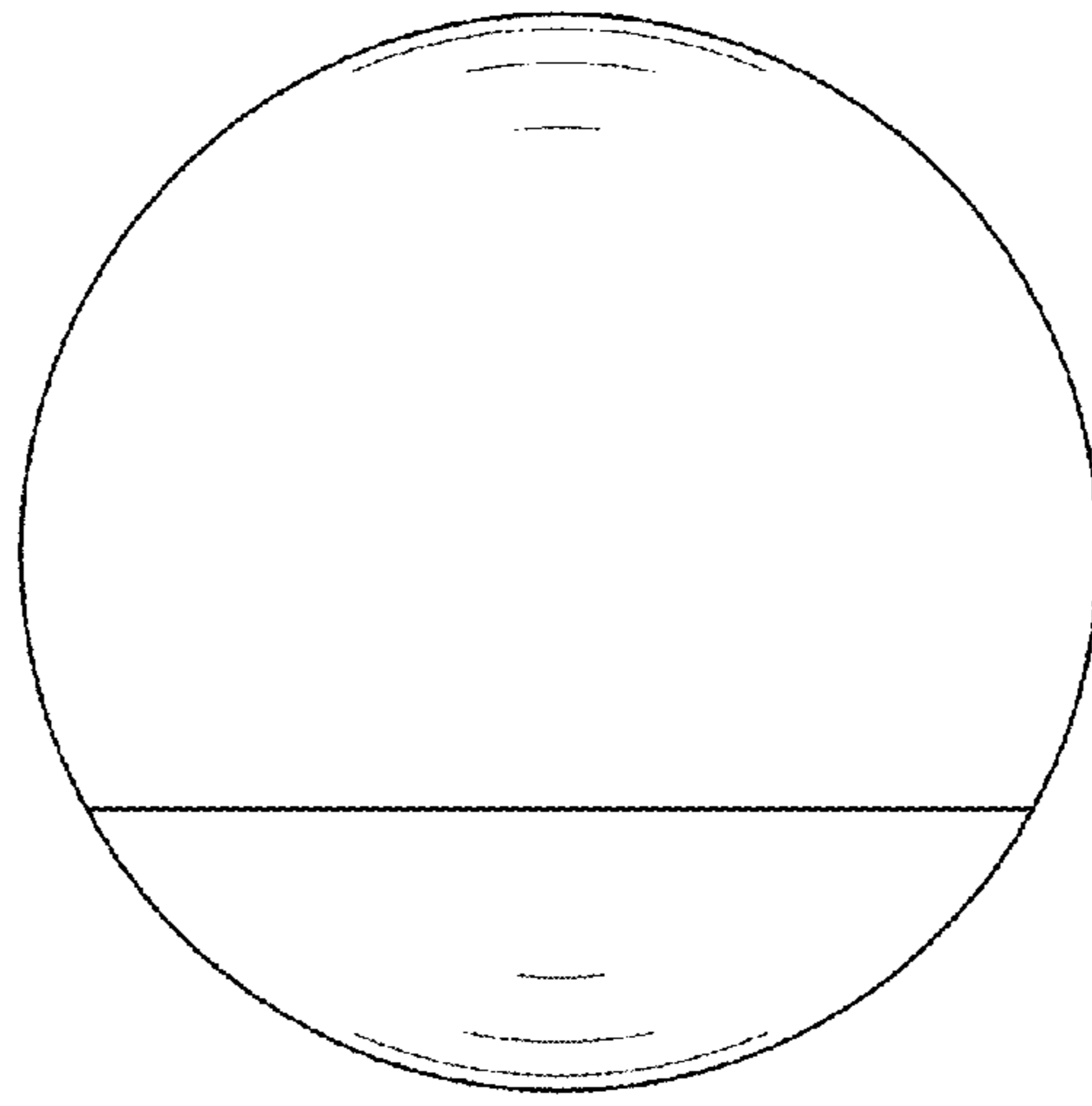


FIG. 7

